# Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

# /!\ REMINDERS

■ Product information in this catalog is as of October 2008. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment. (for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation, (automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel"). It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations," and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

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# コモンモードチョークコイル (ACライン用) リードタイプ **COMMON MODE CHOKE COILS** (FOR AC LINES) LEADED TYPE

等価回路 (Equivalent circuit)

TLF9UAタイプ:−25~+115℃ **OPERATING** TLF14CBタイプ: -20~+105℃ TEMP. TLF25RAタイプ: -25~+105℃

(製品自己発熱を含む) (Including self-generated heat)





### 特長 FEATURES

・TLF 9UA (H) タイ	プ	… 小型形状
・TLF14CB (H)タイ	プ	… 普通形状
・TLF25RA タイプ		大電流容量

- TLF 9UA (H) TYPE ...... Small-sized configuration • TLF14CB (H) TYPE......Ordinary configuration
- TLF25RA TYPE ...... Large current capacity for power supply line use

### **APPLICATIONS**

TV、VTR、SW電源,NCマシン、コンピュータおよび周辺機器,各種計測器、 各種制御装置などの雑音端子電圧、電源ラインノイズ対策

- ・TLF14CB (H) TYPE ······· 入力電力数10W の機器

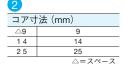
As a preventive measure against noise terminal voltage or power supply noise in TV or VTR units, SW power supplies, NC machines, computer systems, peripheral units, measuring instruments, and controllers.

- · TLF 9UA (H) Type ......low-current applications • TLF14CB (H) Types.....equipment with several tens of watts of input power
- TLF25RA Type .....high-current applications

#### 形名表記法 **ORDERING CODE**

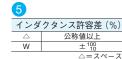


形式	
TLF	ラインフィルタ

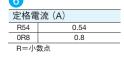




公称インダクタンス (μH) 102 103 10000









# U A H 1 0 2 W 0 R



2	
Core c	limensions (mm)
△9	9
1 4	14
2 5	25



4	
Nomin	al Inductance ( $\mu$ H)
example	
102	1000
103	10000

5	
Induc	tance tolerance (%)
$\triangle$	Nominal Values or higher
W	±100 10
	△=Blank space

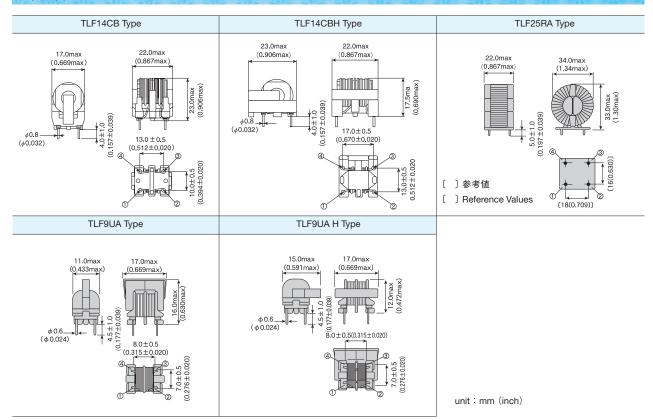
7	
Produc	ct classification code
$\triangle$	Standard
	△=Blank space

Rated	current (A)
R54	0.54
0R8	0.8



△=Blank space

### 外形寸法 EXTERNAL DIMENSIONS









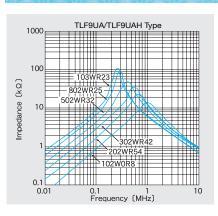


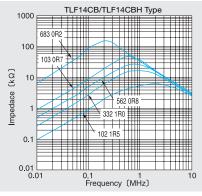


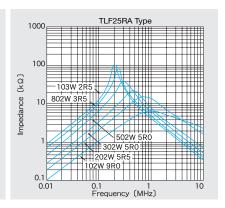
## アイテム一覧 PART NUMBERS

	形名	EHS	/\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \	インダクタンス	直流抵抗[Ω]	定格電流 [A]	定格電圧 [V]	耐電圧 [V]	適用周波数 [MHz]
Type	//2 14	(Environmental	インダクタンス [mH]	許容差	DC resistance		Rated voltage	Withstanding	Applicable
		Hazardous		Inductance				voitage	frequency 参考値
	Ordering code	Substances)	Inductance	Tolerance	(max)	(max)	(max)	[1 minute] (min)	多专胆 Reference Value
	TLF 9UA 102W0R8	RoHS	1	+100%/-10%	0.5	0.80		(111111)	neierence value
	TLF 9UA 202WR54	RoHS	2	+100%/-10%	1.0	0.54	_		
	TLF 9UA 302WR42	RoHS	3	+100%/-10%	1.5	0.42	-		
TLF9UA	TLF 9UA 502WR32	RoHS	5	+100%/-10%	2.5	0.32	-		
	TLF 9UA 802WR25	RoHS	8	+100%/-10%	4.0	0.25	1		
	TLF 9UA 103WR23	RoHS	10	+100%/-10%	4.5	0.23	1		
	TLF 9UAH 102W0R8	RoHS	1	+100%/-10%	0.5	0.80	1		
	TLF 9UAH 202WR54	RoHS	2	+100%/-10%	1.0	0.54	-		
	TLF 9UAH 302WR42	RoHS	3	+100%/-10%	1.5	0.42	1		
TLF9UAH	TLF 9UAH 502WR32	RoHS	5	+100%/-10%	2.5	0.32	1		
	TLF 9UAH 802WR25	RoHS	8	+100%/-10%	4.0	0.25	1		
	TLF 9UAH 103WR23	RoHS	10	+100%/-10%	4.5	0.23	1		
	TLF14CB 102 1R5	RoHS	1.0	min	0.1	1.5	1		
	TLF14CB 222 1R2	RoHS	2.2	min	0.18	1.2	1		
	TLF14CB 332 1R0	RoHS	3.3	min	0.32	1.0	]		
	TLF14CB 472 1R0	RoHS	4.7	min	0.38	1.0			
	TLF14CB 562 0R8	RoHS	5.6	min	0.42	0.8			
TI 54 40D	TLF14CB 682 0R8	RoHS	6.8	min	0.6	0.8	]		
TLF14CB	TLF14CB 103 0R7	RoHS	10	min	0.85	0.7			0.1~10
	TLF14CB 223 0R4	RoHS	22	min	1.7	0.4		AC2000	
	TLF14CB 333 0R3	RoHS	33	min	2.7	0.3			
	TLF14CB 473 0R2	RoHS	47	min	3.6	0.2	AC250		
	TLF14CB 563 0R2	RoHS	56	min	5	0.2			
	TLF14CB 683 0R2	RoHS	68	min	6.5	0.2			
	TLF14CBH 102 1R5	RoHS	1.0	min	0.1	1.5			
	TLF14CBH 222 1R2	RoHS	2.2	min	0.18	1.2	_		
	TLF14CBH 332 1R0	RoHS	3.3	min	0.32	1.0			
	TLF14CBH 472 1R0	RoHS	4.7	min	0.38	1.0			
	TLF14CBH 562 0R8 TLF14CBH 682 0R8	RoHS	5.6	min	0.42	0.8			
TLF14CBH		RoHS RoHS	6.8	min		0.8			
	TLF14CBH 103 0R7 TLF14CBH 223 0R4	RoHS	10 22	min min	0.85 1.7	0.7	-		
	TLF14CBH 223 0R4 TLF14CBH 333 0R3	RoHS	33	min	2.7	0.4	-		
	TLF14CBH 473 0R2	RoHS	47	min	3.6	0.3	-		
	TLF14CBH 563 0R2	RoHS	56	min	5	0.2			
	TLF14CBH 683 0R2	RoHS	68	min	6.5	0.2	-		
	TLF25RA 102W9R0	RoHS	1	+100%/-10%	0.03	9.0	1		
	TLF25RA 102W5R5	RoHS	2	+100%/-10%	0.05	5.5	-		
	TLF25RA 302W5R0	RoHS	3	+100%/-10%	0.06	5.0	1		
TLF25RA	TLF25RA 502W5R0	RoHS	5	+100%/-10%	0.07	5.0	1		
	TLF25RA 802W3R5	RoHS	8	+100%/-10%	0.11	3.5	1		0.1~20
	TLF25RA 103W2R5	RoHS	10	+100%/-10%	0.17	2.5	1		

## インピーダンス一周波数特性 IMPEDANCE-FREQUENCY CHARACTERISTIC







(測定条件)

使用測定器: HP-4192A

Vosc-0.35V

測定回路 インピーダンス アナライザーへ Test conditions

Equipment: HP-4192A

Vosc-0.35V

Test circuit

To impedance analyzer

### **PACKAGING** 梱包

最小受注単位数 Minimum Quantity

CM / BU Type

· · · · · · · · · · · · · · · · · · ·						
	最小受注単位数 (pcs.)					
T	Minimum Quantity					
Type	箱づめ	袋づめ				
	Box	Bulk				
CM05RA06	_	500				
CM05RB	1000	_				
CM08RA□□	_	250				
CM08RB□□	500	_				
CM12RA02	_	100				
BU08RA	_	200				
,						

TLF Type

	· -· · · / F · ·						
		最小受注単位数 (pcs.)					
Tuno	Туре	Minimum Quantity					
	туре	箱づめ					
		Box					
	TLF9UA□	500					
	TLF9UB□	500					
	TLF14CB□	500					
	TLF25RA	200					

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	Specified Value						
Item	CM-RA/ BU-RA Type	CM-RB Type	TLF9U TLF14CB	TLF25RA	Test method and remarks		
1.Operating Temperature	-25~+105°C		TLF9U: -25~+115℃	-25~+105°C	Including temperature rise due to self—generated heat.		
Range			TLF14CB: -20~+105℃				
2.Storage temperature range	-40~+85°C						
3.Rated current	Within the specifed rang	je			CM: The maximum DC value having temperature increase within specified temperature, as detailed in individual specification.  TLF9UA, 14CB, 25RA: The maximum AC value having temperature increase within 45°C by the application of AC current.		
					TLF9UB: The maximum DC value having temperature increase within 45°C by the application of DC current.		
4.Inductance	Within the specifed toler	rance			CM: Measuring equipmet: 4262A (HP) or its equivalent Measuring frequency: 1kHz		
					TLF9U, 25RA:  Measuring equipment: Impedance analyzer (HP4192A) or its equivalent  Measuring frequency: 1kHz  Measuring voltage: 0.35Vosc  TLF14CB:  Measuring equipment: LCR meter 4284A or its equivalent		
					Measuring frequency: 1kHz Measuring voltage: 1.0V		
5.DC resistance	Within the specifed toler	rance			CM, TLF:  Measuring equipment: DC ohmmeter		
6.Terminal strength tensile force	No abnormality				CM: Fix the component in the direction to draw terminal and gradually apply tensile force as detailed in indiviual specifications.  TLF9U: Apply the stated tensile force gradually in the direction		
					to draw terminal.		
					Nominal wire diameter tensile $\phi$ d force duration (mm) (N) (S)		
					(mm) (N) (S) φ0.6 5 30±5		
					TLF14CB: Apply the stated tensile force gradually in the direction to draw terminal.		
					Nominal wire diameter tensile φd force duration		
					(mm) (N) (S)		
7.Temperature rise	Refer to individual speci	ification	45°C max.		TLF: Resistance substitution method Applied current: Rated current Duration: 1 hr		
8.Insulation resistance	100MΩmin.				CM·TLF:		
between wires					Applied voltage : Rated voltage (CM-RA/BU-RA, CM-RB) : 500VDC (TLF9UA, 14CB, 25RA) : 250VDC (TLF 9 UB)  Duration : 60sec.		
9.Insulation resistance between wire and core			100M Ω min.		TLF: Applied voltage: 500VDC (TLF9UA、14CB) : 250VDC (TLF 9 UB)  Duration: 60 sec.		
	1		1	1			

		Specifie	ed Value		
ltem	CM-RA/ BU-RA Type	CM—RB Type	TLF9U TLF14CB	TLF25RA	Test method and remarks
10.Withstanding : between wires	No abnormality				CM·TLF: Applied voltage: 250VDC (CM-RA/BU-RA, CM-RB) : 2000VAC (TLF9UA, 14CB, 25RA) : 500VDC (TLF 9 UB) Duration: 60sec.
11.Withstanding : between wires and core			No abnormality		TLF: Applied voltage: 2000VAC (TLF9UA、14CB) : 500VDC (TLF9UB) Duration: 60sec.
12.Rated voltage	Within the specified ran	ge		1	TLF9UA, 14CB, 25RA: 250VAC TLF9UB: 50VDC
13.Resistance to vibration		Appearance: No abnormality Inductance change: Within±15%	TLF9U Inductance change: Within±5% TLF14CB Within the specified range		COM, TLF:  According to JIS C0040  Direction: 2hrs each in X, Y and Z direction Total: 6hrs  Frequency range: 10 to 55 to 10Hz (1 min.)  Amplitude: 1.5mm (shall not exceed acceleration 196m²/s)  Mounting method: soldering onto PC board  Recovery: 2 to 24 hrs of recovery under the standard condition after the test. (CM—RB)  : At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. (TLF9U, 14CB)
14.Solderability	At least 75% of termina new solder.	al electrode is covered by	Solder shall be unifo mersed surfaces.	rmly adhered onto im-	CM: Solder temperature: 235±5°C Duration: 2±0.5sec. Immersion depth: According to detailed specification.  TLF: Solder temperature: 230±5°C Duration: 2±0.5sec. (9U, 25RA) : 3±0.5sec. (14CB) Immersion depth: Up to 1.0 to 1.5mm from PBC mounted level.
15.Resistance to soldering heat	Appearance : No abnor Impedance change : F cation	rmality Refer to individual specifi-	TLF9UA • TLF25RA : Inductance change : W TLF14CB Within the specified ran		CM: Solder temperature: 260±5°C Duration: 5±0.5sec. Immersion depth: Up to 2~2.5mm from terminal root. Recovery: 1 to 2 hrs of recovery under the standard condition after the test.  TLF: Solder temperature: 260±5°C Duration: 5±1sec. (25RA) : 10±1sec. (9U、 14CB) Immersion depth: Up to 1.0 to 1.5mm from PBC mounted level. Recovery: At least 1hr of recovery under the standard condition after the removal from test chambe

	Specified Value						
ltem	CM-RA/ BU-RA Type	CM-RB Type	TLF9U TLF14CB	TLF25RA		Test method and rea	marks
16.Thermnal shock	Appearance : No abnor	mality lefer to individual specifi-	TLF9UA · TLF25RA : Inductance change : W TLF14CB : · Withstanding voltage · Insulation resistance :	: No abnormality	Conditions Step 1 2 3 4 Number of	Temperature (°C)  -25±3  Room Temperature  +85±2  Room Temperature	val from test chamber,
-450							
17.Damp heat			TLF9UA · TLF25RA : Inductance change : W TLF14CB : Withstanding voltage : Insulation resistance : I	No abnormality	Humidity : 9 Duration : 5 Recovery :	Temperature : 40±2°C 90~95%RH	y under the standard
18. Loading under damp heat	Appearance: No abnormality Inductance change: Refer to individual specification		Withstanding voltage: Insulation resistance: I		measurement within 2 hrs.  CM: Temperature: 40±2°C Humidity: 90~95%RH Duration: 500 (+12, -0) hrs Applied current: Rated current Recovery: 1 to 2hrs of recovery under the standard dition after the removal from test chambe		nder the standard con-
					Humidity : 9 Duration : 1 Applied vol  TLF9U TLF9U **TLF14CE Recovery :	Temperature : 40±2°C 90~95%RH 00 hrs tage : Apply the follow between windin A. 25RA 250VAC	wing specified voltage gs. Apply rated current rindings y under the standard nber followed by the
19.Loading at high temperature			Withstanding voltage : tion resistance : No abi	No abnormality Insula- normality	TLF9U TLF9U **TLF14CB Apply rated	00 hrs tage: Apply the follow between windin A. 25RA 250VAC	gs. s ry under the standard imber followed by the

	Specified Value					
ltem	CM-RA/ BU-RA Type	СМ—RВ Туре	TLF9U TLF14CB	TLF25RA	Test method and remarks	
20.Low temperature life test	Appearance : No abnormality Inductance change : Refer to individual specification		TLF9U • TLF25RA: Inductance change: Within±15%  TLF14CB: • Withstanding voltage: No abnormality • Insulation resistance: No abnormality		CM: Temperature: -40±3°C Duration: 500 (+12, -0) hrs Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.  (CM-RA) : 1 to 2hrs of recovery under the standard condition after the removal from test chamber.  (CM-RB)  TLF: Temperature: -25±2°C %*TLF14CB Temperature: -40±2°C Duration: 500 hrs Recovery: At least 1hr of recovery under the standard removal from test chamber followed by the measurement within 2 hrs.	
21.High Temperature life test	Appearance : No abnormality Inductance change : Refer to individual specification		TLF9U · TLF25RA: Inductance change: Within±15%  TLF14CB: · Withstanding voltage: No abnormality · Insulation resistance: No abnormality		CM: Temperature: 85±2°C Duration: 500 (+12, -0) hrs Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.  (CM-RA) : 1 to 2hrs of recovery under the standard condition after the removal from test chamber.  (CM-RB)  TLF: Temperature: 85±2°C  **TLF14CB Temperature: 105±3°C Duration: 500 hrs Recovery: At least 1hr of recovery under the standard removal from test chamber followed by the measurement within 2 hrs.	

### CM-RA Type, CM-RB Type, TLF Type

Stages	Precautions	Technical considerations
1.Circuit Design	Operating environment,	
	1.The products described in this specification are intended for	
	use in general electronic equipment, (office supply	
	equipment, telecommunications systems, measuring	
	equipment, and household equipment). They are not	
	intended for use in mission-critical equipment or systems	
	requiring special quality and high reliability (traffic systems,	
	safety equipment, aerospace systems, nuclear control	
	systems and medical equipment including life-support	
	systems,) where product failure might result in loss of life,	
	injury or damage. For such uses, contact TAIYO YUDEN	
	Sales Department in advance.	
DCR Decign	Design	1.When Inductors are mounted onto a PC board, hole dimensions on the board should be a possible of the control of the con
2.PCB Design	_	
	1.Please design insertion pitches of a base in the pitches that	match the lead pitch of the component, if not, it will cause breakage of the termina
	fitted a terminal interval.	or cracking of terminal roots covered with resin as excess stress travels through t
		terminal legs.
3.Soldering	Wave soldering	
	1.Please refer to the specifications in the catalog for a wave	
	soldering.	
	2.Do not immerse the entire Inductors in the flux during the	
	soldering operation.	
	Lead free soldering	
	1.When using products with lead free soldering, we request to	1.If products are used beyond the range of the recommended conditions, heat stress
	use them after confirming of adhesion, temperature of	may deform the products, and consequently degrade the reliability of the products.
	resistance to soldering heat, etc. sufficiently.	
	Recommended conditions for using a soldering iron	
	Put the soldering iron on the land-pattern.	
	Soldering iron's temperature - Below 350 °C	
	Duration - 3 seconds or less	
1 Classins	The soldering iron should not directly touch the product.	
4.Cleaning	Cleaning conditions	
	1.TLF type	
	Please contact any of our offices for about a cleaning,	
5.Handling	Handling	
	1.Keep the product away from all magnets and magnetic	1.There is a case that a characteristic varies with magnetic influence.
	objects.	
	Mechanical considerations	
	1.Please do not give the product any excessive mechanical	1.There is a case to be damaged by a mechanical shock.
	shocks.	
	2.TLF type	2.TLF type
	Please do not add any shock or and power to a product in	There is a case to be broken by a fall.
	transportation.	
	Packing	
	1.Please do not give the product any excessive mechanical	1.There is a case that a lead route turns at by a fall or an excessive shock.
	shocks.	This is a case that a load route turns at by a lan or an oxecoure critical.
	In loading, please pay attention to handling indication	
	mentioned in a packing box (a loading direction / number of	
	maximum loading / fragile item).	
6.Storage conditions	Storage	
	1.To maintain the solderability of terminal electrodes and to	Under a high temperature and humidity environment, problems such as reduce
	keep the packing material in good condition, temperature	solderability caused by oxidation of terminal electrodes and deterioration
	and humidity in the storage area should be controlled.	taping/packaging materials may take place.
	•Recommended conditions	
	Ambient temperature 0~40°C	
	Humidity Below 70% RH	
	The ambient temperature must be kept below 30°C. Even	
	under ideal storage conditions, solderability of products	
	electrodes may decrease as time passes. For this reason,	
	product should be used within one year from the time of	
	delivery.	
	In case of storage over 6 months, solderability shall be checked before actual usage.	